









Release Date: 04 June 2022 Version: A1.1

PRODUCT DATASHEET



- ► PLCC8 SMD
- ➤ 3735 1.8t Series
- ► Natural White / Red / Green / Blue

WRGB N0M61S11





3735 1.8t Series





FEATURES (Natural White/Red/Green/Blue):

- Package: PLCC8 WRGB Top View SMD Package
- Forward Current: 20/20/20/20mA *
- Forward Voltage (typ.): 3.3/2.2/3.3/3.3V
- Luminous Flux (typ.): 2370/850/1800/470mcd@20mA
- Colour: Natural White/Red/Green/Blue
- CCT/Wavelength: 4000K/622/525/467nm
- Viewing angle: 120°
- Materials:
 - Die: InGaN/AlGaInP/InGaN/InGaN
 - Resin: Silicon (Yellow/White Diffused)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **ESD:** 1000V (HBM)
- **Grouping parameters:**
 - Forward voltage
 - Luminous intensity
 - CIE Chromaticity/Dominant Wavelength
- Soldering methods: Reflow soldering
- Preconditioning: MSL 5a according to JEDEC
- Packing: 12mm tape with max.1000pcs/reel, ø180mm (7")

APPLICATIONS:

- **LED Display**
- Switch Light
- 3C Application
- **Decoration Lighting**
- **Amusement Lighting**
- **Architecture Lighting**
- **LED Light Strip**

^{*} In the order of Natural White/Red/Green/Blue.



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	30	mA
Pulse Forward Current (duty 1/10; width 0.1ms)	Імах	70	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	I _R	10	μΑ
Electrostatic Discharge (HBM)	ESD	1000	٧
Junction Temperature	Tj	110	°C
Soldering Temperature	T _{sol}	260	°C
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C



Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Values Typ.	Max.	Unit	Test Condition
White - Forward Voltage	V _F	2.8		3.6	V	I _F =20mA
White- Luminous Intensity	I _V	1400	2370	4000	mcd	I _F =20mA
White	Х		0.3820			
Chromaticity Coordinates	Υ		0.3800			I _F =20mA
Colour Temperature	ССТ	3800	4000	4200	К	I _F =20mA
Red - Forward Voltage	V _F	1.8		2.6	V	I _F =20mA
Red - Luminous Intensity	Iv	440	850	1250	mcd	I _F =20mA
Red - Wavelength	Wp	618		628	nm	I _F =20mA
Green - Forward Voltage	V _F	2.8		3.6	V	I _F =20mA
Green - Luminous Intensity	Ιν	1000	1800	3050	mcd	I _F =20mA
Green - Wavelength	W _P	520		530	nm	I _F =20mA
Blue - Forward Voltage	V _F	2.8		3.6	V	I _F =20mA
Blue - Luminous Intensity	Iv	210	470	620	mcd	I _F =20mA
Blue - Wavelength	Wp	460		475	nm	I _F =20mA
RGB Mix Chromaticity Coordinates	Х		0.2550			1 20 1
	Υ		0.2360			I _F =20mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA

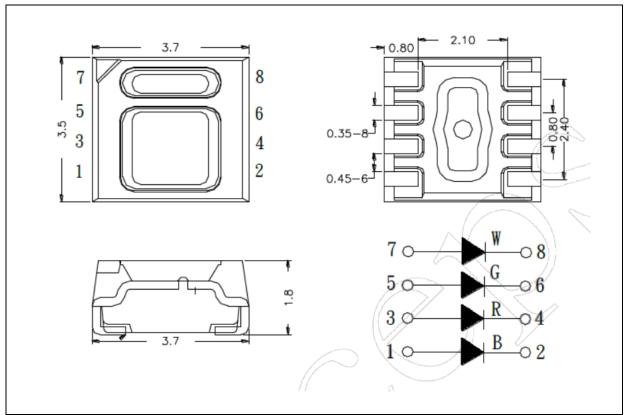
^{1.} Luminous intensity (I_V) $\pm 10\%$, Forward Voltage (V_F) $\pm 0.1V$, Viewing angle($2\theta_{1/2}$) $\pm 5\%$, Wavelength (λ) ± 1 nm.

^{2.} The bin will be amended to maintain bin centralization. The Luminous Intensity will be 1.3 times per bin and the Dominant Wavelength is 5nm per R/G/B bin.



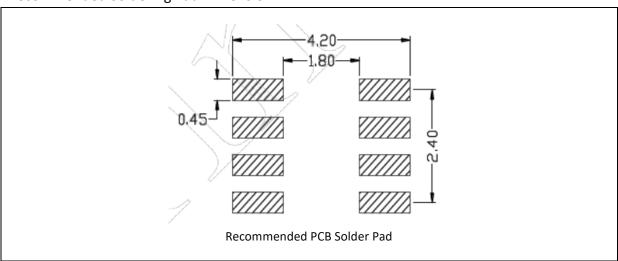
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

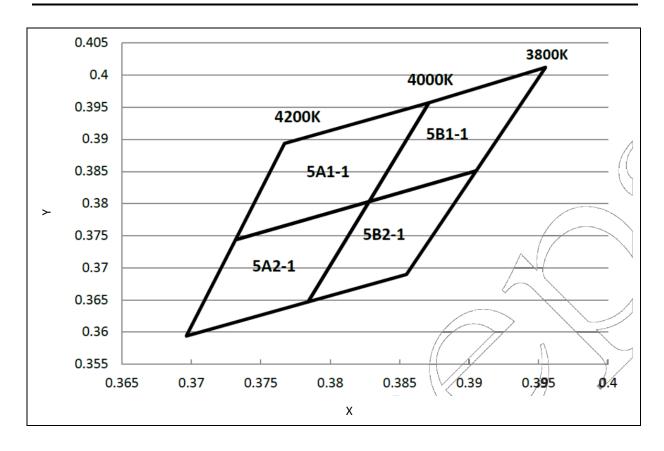
Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



CIE CHROMATICITY DIAGRAM (WHITE):

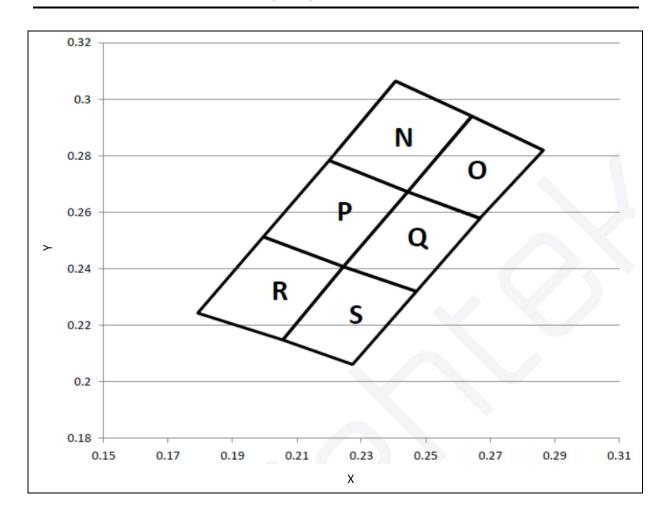


Chromaticity Coordinates Classifications (I_F = 20mA):

	1	l	2		3		4	
	X	Υ	X	Υ	X	Υ	Х	Υ
5A1-1	0.3767	0.3893	0.3871	0.3957	0.3828	0.3803	0.3731	0.3743
5A2-1	0.3731	0.3743	0.3828	0.3803	0.3784	0.3647	0.3696	0.3594
5B1-1	0.3871	0.3957	0.3955	0.4012	0.3905	0.3851	0.3828	0.3803
5B2-1	0.3828	0.3803	0.3905	0.3851	0.3854	0.3689	0.3784	0.3647



CIE CHROMATICITY DIAGRAM (RGB):

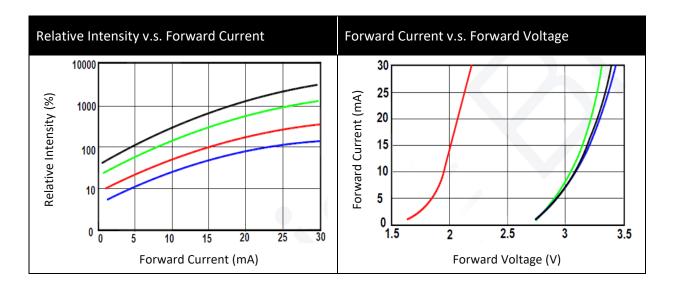


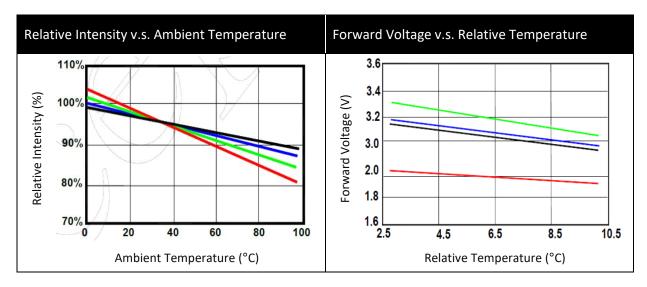
Chromaticity Coordinates Classifications:

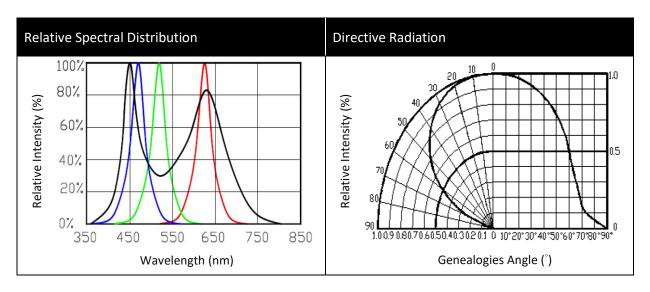
	1	1	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
N	0.2200	0.2783	0.2406	0.3064	0.2643	0.2940	0.2444	0.2672
0	0.2444	0.2672	0.2643	0.2940	0.2865	0.2819	0.2667	0.2578
Р	0.2200	0.2783	0.1996	0.2513	0.2244	0.2407	0.2444	0.2672
Q	0.2444	0.2672	0.2244	0.2407	0.2471	0.2320	0.2669	0.2579
R	0.1996	0.2513	0.1792	0.2243	0.2056	0.2148	0.2244	0.2407
S	0.2244	0.2407	0.2056	0.2148	0.2273	0.2061	0.2471	0.2320



ELECTRO-OPTICAL CHARACTERISTICS:

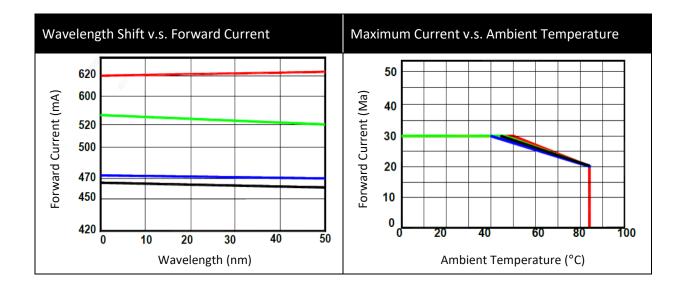








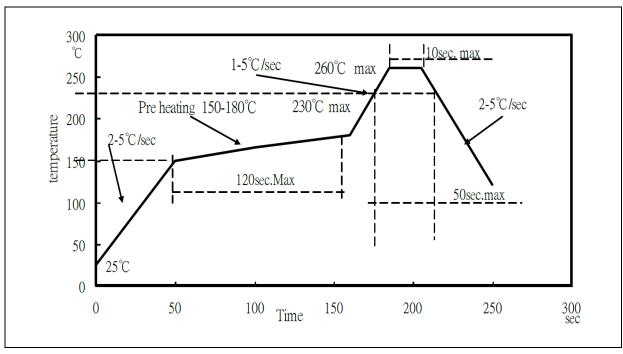
ELECTRO-OPTICAL CHARACTERISTICS:





RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



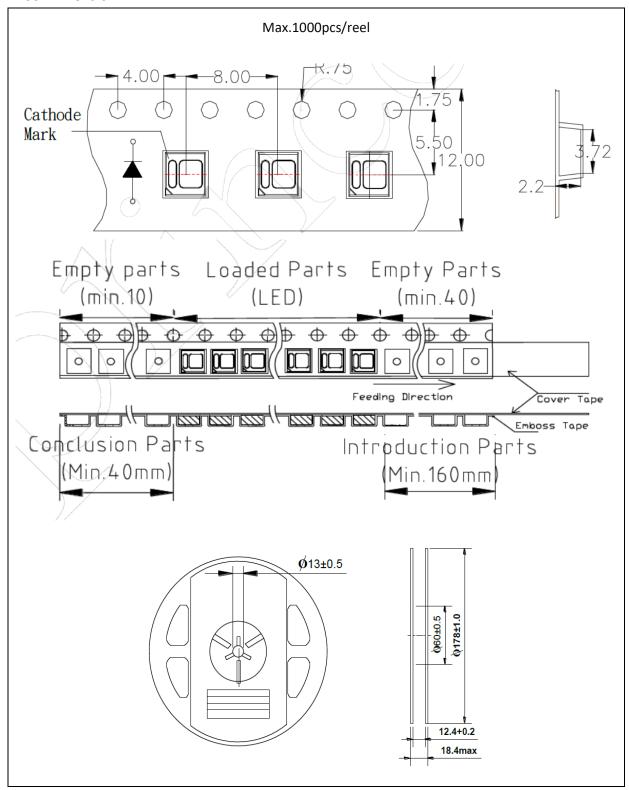
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Recommended reflow temperature is 240°C; the maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 48 hours. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

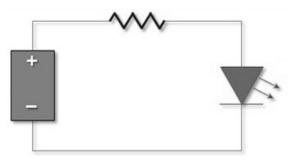
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision			
A1.0	16/04/2019	Datasheet set-up.			
A1.1	04/06/2022	New datasheet format.			